INTEGRATED CIRCUITS

DATA SHEET



PCF8591 8-bit A/D and D/A converter

Product specification Supersedes data of 2001 Dec 13 2003 Jan 27





8-bit A/D and D/A converter

PCF8591

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1 FEATURES

- · Single power supply
- Operating supply voltage 2.5 V to 6 V
- · Low standby current
- Serial input/output via I2C-bus
- · Address by 3 hardware address pins
- Sampling rate given by I²C-bus speed
- 4 analog inputs programmable as single-ended or differential inputs
- Auto-incremented channel selection
- Analog voltage range from V_{SS} to V_{DD}
- · On-chip track and hold circuit
- 8-bit successive approximation A/D conversion
- · Multiplying DAC with one analog output.

2 APPLICATIONS

- Closed loop control systems
- Low power converter for remote data acquisition
- · Battery operated equipment
- Acquisition of analog values in automotive, audio and TV applications.



3 GENERAL DESCRIPTION

The PCF8591 is a single-chip, single-supply low power 8-bit CMOS data acquisition device with four analog inputs, one analog output and a serial I²C-bus interface. Three address pins A0, A1 and A2 are used for programming the hardware address, allowing the use of up to eight devices connected to the I²C-bus without additional hardware. Address, control and data to and from the device are transferred serially via the two-line bidirectional I²C-bus.

The functions of the device include analog input multiplexing, on-chip track and hold function, 8-bit analog-to-digital conversion and an 8-bit digital-to-analog conversion. The maximum conversion rate is given by the maximum speed of the I²C-bus.

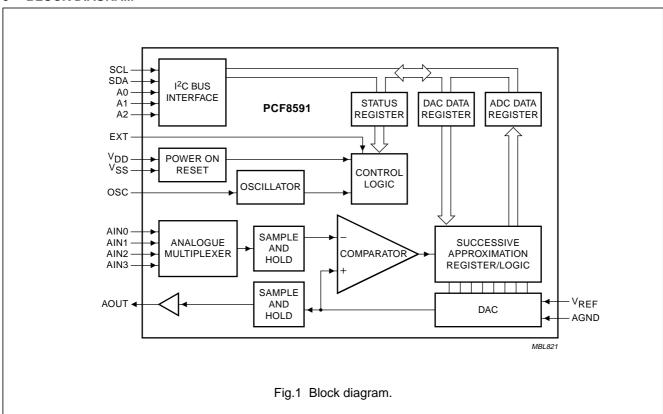
4 ORDERING INFORMATION

TYPE		PACKAGE								
NUMBER	NAME	DESCRIPTION								
PCF8591P	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4							
PCF8591T	SO16	plastic small outline package; 16 leads; body width 7.5 mm	SOT162-1							

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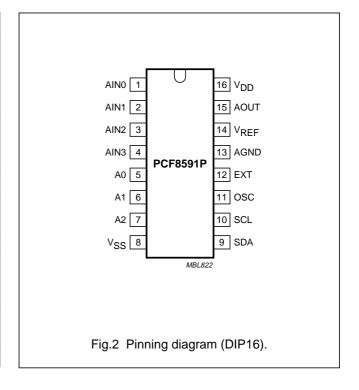
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5 BLOCK DIAGRAM



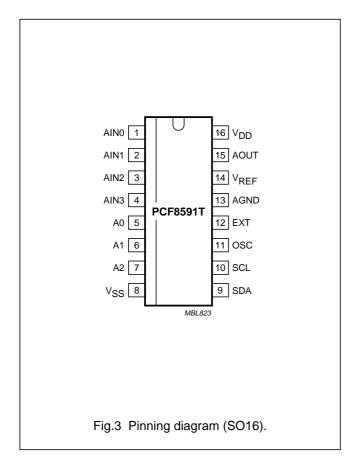
6 PINNING

SYMBOL	PIN	DESCRIPTION
AINO	1	analog inputs (A/D converter)
AIN1	2	
AIN2	3	
AIN3	4	
A0	5	hardware address
A1	6	
A2	7	
V _{SS}	8	negative supply voltage
SDA	9	I ² C-bus data input/output
SCL	10	I ² C-bus clock input
OSC	11	oscillator input/output
EXT	12	external/internal switch for oscillator input
AGND	13	analog ground
V _{REF}	14	voltage reference input
AOUT	15	analog output (D/A converter)
V_{DD}	16	positive supply voltage



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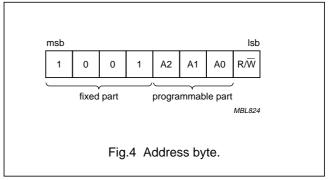
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7 FUNCTIONAL DESCRIPTION

7.1 Addressing

Each PCF8591 device in an I²C-bus system is activated by sending a valid address to the device. The address consists of a fixed part and a programmable part. The programmable part must be set according to the address pins A0, A1 and A2. The address always has to be sent as the first byte after the start condition in the I²C-bus protocol. The last bit of the address byte is the read/write-bit which sets the direction of the following data transfer (see Figs 4, 16 and 17).



7.2 Control byte

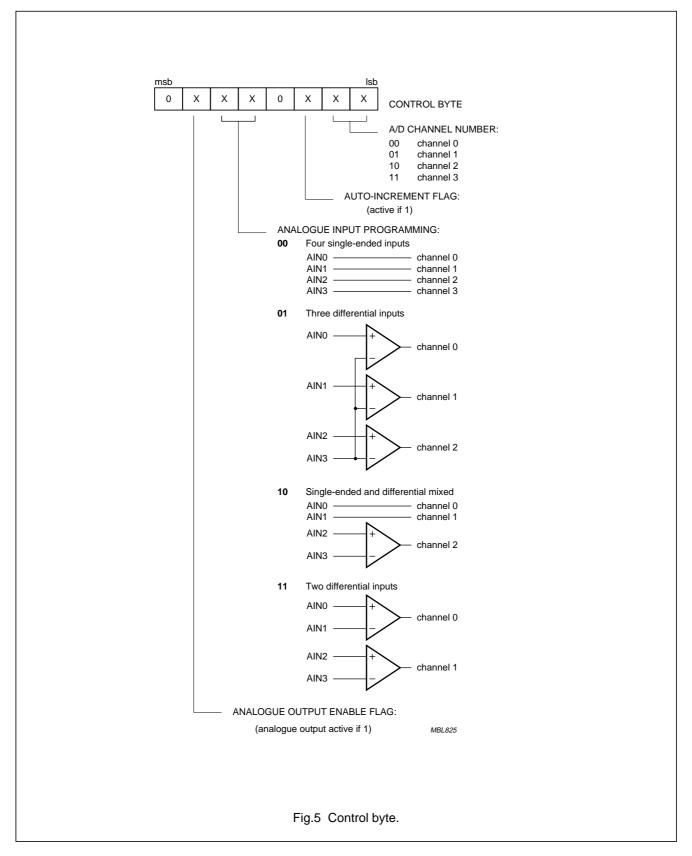
The second byte sent to a PCF8591 device will be stored in its control register and is required to control the device function. The upper nibble of the control register is used for enabling the analog output, and for programming the analog inputs as single-ended or differential inputs. The lower nibble selects one of the analog input channels defined by the upper nibble (see Fig.5). If the auto-increment flag is set, the channel number is incremented automatically after each A/D conversion.

If the auto-increment mode is desired in applications where the internal oscillator is used, the analog output enable flag in the control byte (bit 6) should be set. This allows the internal oscillator to run continuously, thereby preventing conversion errors resulting from oscillator start-up delay. The analog output enable flag may be reset at other times to reduce quiescent power consumption.

The selection of a non-existing input channel results in the highest available channel number being allocated. Therefore, if the auto-increment flag is set, the next selected channel will be always channel 0. The most significant bits of both nibbles are reserved for future functions and have to be set to logic 0. After a Power-on reset condition all bits of the control register are reset to logic 0. The D/A converter and the oscillator are disabled for power saving. The analog output is switched to a high-impedance state.

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7.3 D/A conversion

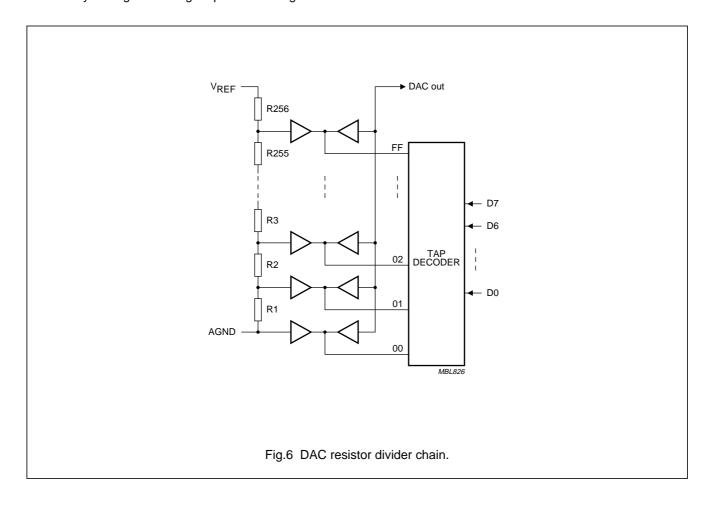
The third byte sent to a PCF8591 device is stored in the DAC data register and is converted to the corresponding analog voltage using the on-chip D/A converter. This D/A converter consists of a resistor divider chain connected to the external reference voltage with 256 taps and selection switches. The tap-decoder switches one of these taps to the DAC output line (see Fig.6).

The analog output voltage is buffered by an auto-zeroed unity gain amplifier. This buffer amplifier may be switched on or off by setting the analog output enable flag of the

control register. In the active state the output voltage is held until a further data byte is sent.

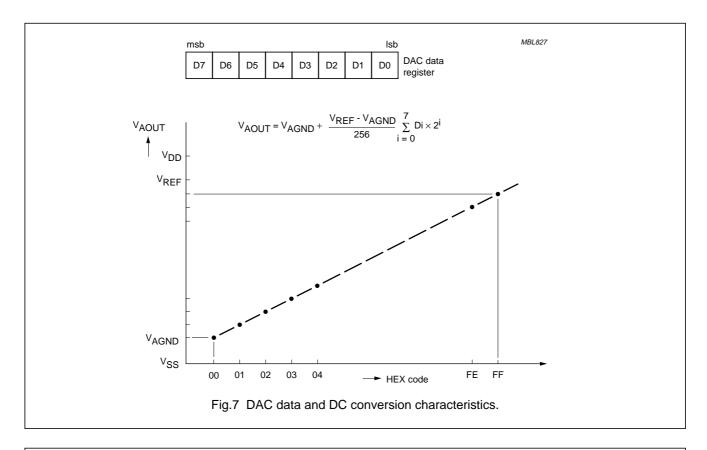
The on-chip D/A converter is also used for successive approximation A/D conversion. In order to release the DAC for an A/D conversion cycle the unity gain amplifier is equipped with a track and hold circuit. This circuit holds the output voltage while executing the A/D conversion.

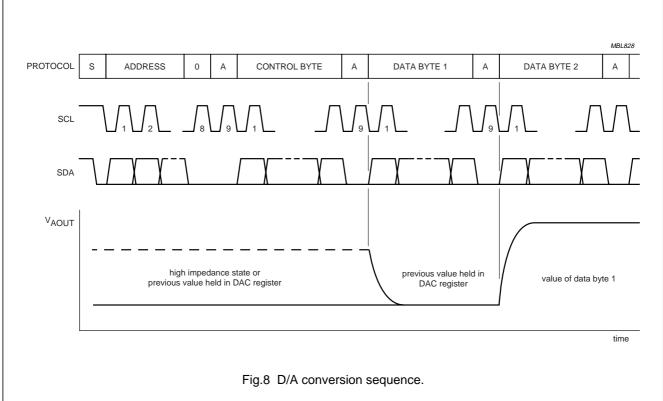
The output voltage supplied to the analog output AOUT is given by the formula shown in Fig.7. The waveforms of a D/A conversion sequence are shown in Fig.8.



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7.4 A/D conversion

The A/D converter makes use of the successive approximation conversion technique. The on-chip D/A converter and a high-gain comparator are used temporarily during an A/D conversion cycle.

An A/D conversion cycle is always started after sending a valid read mode address to a PCF8591 device. The A/D conversion cycle is triggered at the trailing edge of the acknowledge clock pulse and is executed while transmitting the result of the previous conversion (see Fig.9).

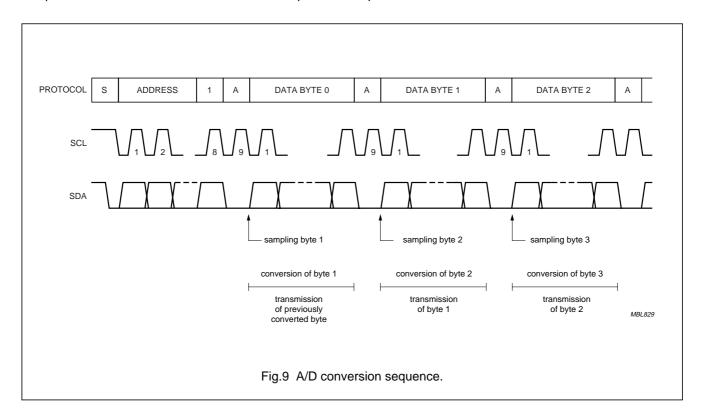
Once a conversion cycle is triggered an input voltage sample of the selected channel is stored on the chip and is

converted to the corresponding 8-bit binary code. Samples picked up from differential inputs are converted to an 8-bit twos complement code (see Figs 10 and 11).

The conversion result is stored in the ADC data register and awaits transmission. If the auto-increment flag is set the next channel is selected.

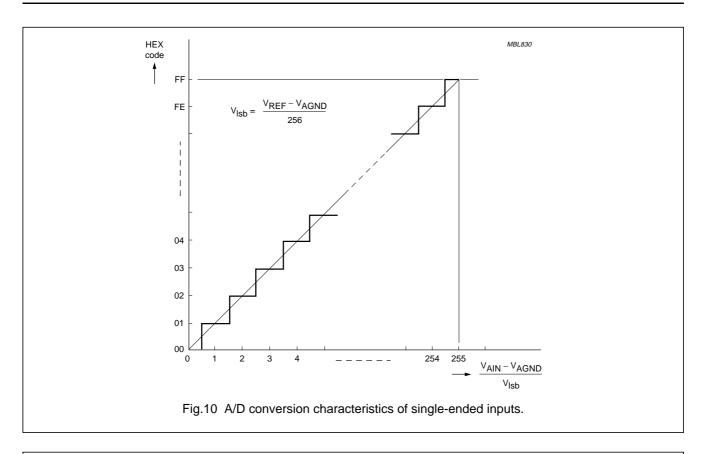
The first byte transmitted in a read cycle contains the conversion result code of the previous read cycle. After a Power-on reset condition the first byte read is a hexadecimal 80. The protocol of an I²C-bus read cycle is shown in Chapter 8, Figs 16 and 17.

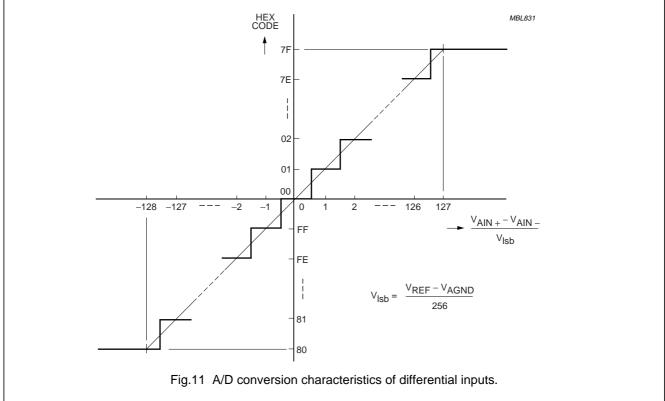
The maximum A/D conversion rate is given by the actual speed of the I²C-bus.



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7.5 Reference voltage

For the D/A and A/D conversion either a stable external voltage reference or the supply voltage has to be applied to the resistor divider chain (pins V_{REF} and AGND). The AGND pin has to be connected to the system analog ground and may have a DC off-set with reference to V_{SS} .

A low frequency may be applied to the V_{REF} and AGND pins. This allows the use of the D/A converter as a one-quadrant multiplier; see Chapter 15 and Fig.7.

The A/D converter may also be used as a one or two quadrant analog divider. The analog input voltage is divided by the reference voltage. The result is converted to a binary code. In this application the user has to keep the reference voltage stable during the conversion cycle.

7.6 Oscillator

An on-chip oscillator generates the clock signal required for the A/D conversion cycle and for refreshing the auto-zeroed buffer amplifier. When using this oscillator the EXT pin has to be connected to V_{SS} . At the OSC pin the oscillator frequency is available.

If the EXT pin is connected to V_{DD} the oscillator output OSC is switched to a high-impedance state allowing the user to feed an external clock signal to OSC.

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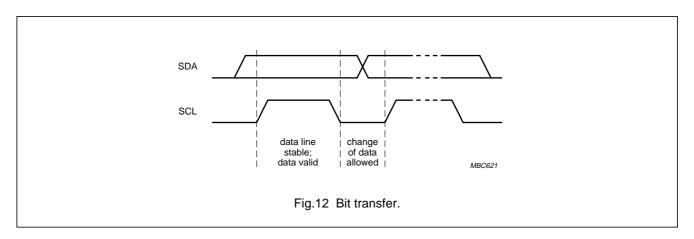
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8 CHARACTERISTICS OF THE I2C-BUS

The I²C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

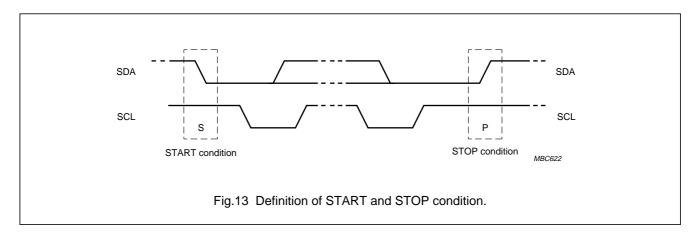
8.1 Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal.



8.2 Start and stop conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH, is defined as the start condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH, is defined as the stop condition (P).

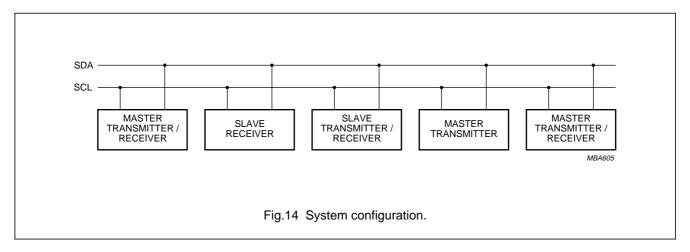


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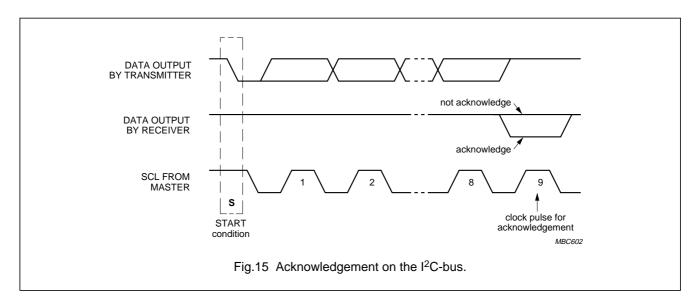
8.3 System configuration

A device generating a message is a 'transmitter', a device receiving a message is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves'.



8.4 Acknowledge

The number of data bytes transferred between the start and stop conditions from transmitter to receiver is not limited. Each data byte of eight bits is followed by one acknowledge bit. The acknowledge bit is a HIGH level put on the bus by the transmitter whereas the master also generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter. The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse. A master receiver must signal an end of data to the transmitter by **not** generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a stop condition.

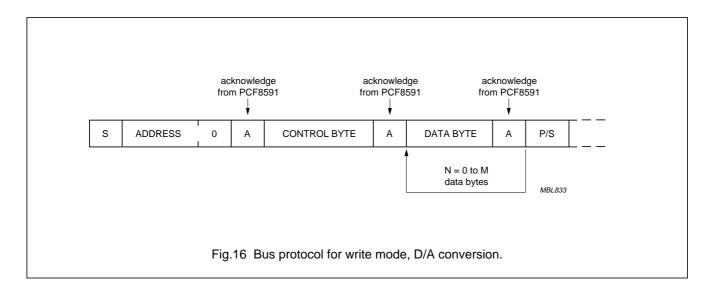


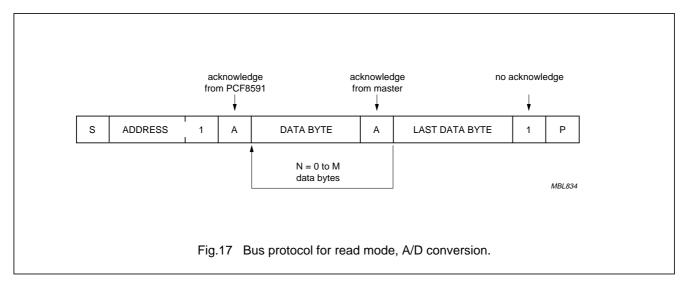
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8.5 I²C-bus protocol

After a start condition a valid hardware address has to be sent to a PCF8591 device. The read/write bit defines the direction of the following single or multiple byte data transfer. For the format and the timing of the start condition (S), the stop condition (P) and the acknowledge bit (A) refer to the I²C-bus characteristics. In the write mode a data transfer is terminated by sending either a stop condition or the start condition of the next data transfer.





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9 LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_{DD}	supply voltage (pin 16)	-0.5	+8.0	V
VI	input voltage (any input)	-0.5	V _{DD} + 0.5	V
I _I	DC input current	_	±10	mA
Io	DC output current	_	±20	mA
I _{DD} , I _{SS}	V _{DD} or V _{SS} current	_	±50	mA
P _{tot}	total power dissipation per package	_	300	mW
Po	power dissipation per output	_	100	mW
T _{amb}	operating ambient temperature	-40	+85	°C
T _{stg}	storage temperature	-65	+150	°C

10 HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However it is good practice to take normal precautions appropriate to handling MOS devices (see "Handling MOS devices").

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11 DC CHARACTERISTICS

 V_{DD} = 2.5 V to 6 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Supply				•		
V_{DD}	supply voltage (operating)		2.5	_	6.0	V
I _{DD}	supply current					
	standby	$V_I = V_{SS}$ or V_{DD} ; no load	_	1	15	μΑ
	operating, AOUT off	f _{SCL} = 100 kHz	_	125	250	μΑ
	operating, AOUT active	f _{SCL} = 100 kHz	_	0.45	1.0	mA
V _{POR}	Power-on reset level	note 1	0.8	_	2.0	V
Digital inp	uts/output: SCL, SDA, A0, A1,	A2				
V _{IL}	LOW level input voltage		0	_	$0.3 \times V_{DD}$	V
V _{IH}	HIGH level input voltage		$0.7 \times V_{DD}$	_	V _{DD}	V
IL	leakage current					
	A0, A1, A2	$V_I = V_{SS}$ to V_{DD}	-250	_	+250	nA
	SCL, SDA	$V_I = V_{SS}$ to V_{DD}	-1	_	+1	μΑ
C _i	input capacitance		_	_	5	pF
I _{OL}	LOW level SDA output current	V _{OL} = 0.4 V	3.0	_	_	mA
Reference	voltage inputs					
V _{REF}	reference voltage	V _{REF} > V _{AGND} ; note 2	V _{SS} + 1.6	_	V _{DD}	V
V _{AGND}	analog ground voltage	V _{REF} > V _{AGND} ; note 2	V _{SS}	_	V _{DD} - 0.8	V
ILI	input leakage current		-250	_	+250	nA
R _{REF}	input resistance	pins V _{REF} and AGND	_	100	_	kΩ
Oscillator	: OSC, EXT					
ILI	input leakage current		_	_	250	nA
f _{OSC}	oscillator frequency		0.75	_	1.25	MHz

Notes

- 1. The power on reset circuit resets the I^2C -bus logic when V_{DD} is less than V_{POR} .
- 2. A further extension of the range is possible, if the following conditions are fulfilled:

$$\frac{V_{REF} + V_{AGND}}{2} \ge 0.8 \, V, \, V_{DD} - \frac{V_{REF} + V_{AGND}}{2} \ge 0.4 \, V$$

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12 D/A CHARACTERISTICS

 V_{DD} = 5.0 V; V_{SS} = 0 V; V_{REF} = 5.0 V; V_{AGND} = 0 V; R_L = 10 k Ω ; C_L = 100 pF; T_{amb} = -40 °C to +85 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Analog ou	ıtput				•	
V _{OA}	output voltage	no resistive load	V _{SS}	_	V _{DD}	V
		$R_L = 10 \text{ k}\Omega$	V _{SS}	_	$0.9 \times V_{DD}$	V
I _{LO}	output leakage current	AOUT disabled	_	_	250	nA
Accuracy			•	•	•	
OS _e	offset error	T _{amb} = 25 °C	_	_	50	mV
L _e	linearity error		_	_	±1.5	LSB
G _e	gain error	no resistive load	_	_	1	%
t _{DAC}	settling time	to ½ LSB full scale step	_	_	90	μs
f _{DAC}	conversion rate		_	_	11.1	kHz
SNRR	supply noise rejection ratio	$f = 100 \text{ Hz};$ $V_{DDN} = 0.1 \times V_{PP}$	_	40	_	dB

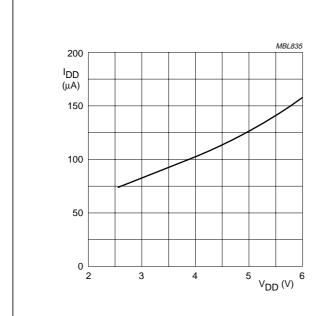
13 A/D CHARACTERISTICS

 $V_{DD} = 5.0 \text{ V}; V_{SS} = 0 \text{ V}; V_{REF} = 5.0 \text{ V}; V_{AGND} = 0 \text{ V}; R_{S} = 10 \text{ k}\Omega; T_{amb} = -40 \text{ °C to +85 °C unless otherwise specified.}$

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Analog in	outs		•	•	•	•
V _{IA}	analog input voltage		V _{SS}	_	V _{DD}	V
I _{LIA}	analog input leakage current		_	_	100	nA
C _{IA}	analog input capacitance		_	10	_	pF
C _{ID}	differential input capacitance		_	10	_	pF
V _{IS}	single-ended voltage	measuring range	V _{AGND}	_	V _{REF}	V
V _{ID}	differential voltage	measuring range; V _{FS} = V _{REF} - V _{AGND}	$\frac{-V_{FS}}{2}$	-	+V _{FS} 2	V
Accuracy			•	•	•	•
OS _e	offset error	T _{amb} = 25 °C	_	_	20	mV
L _e	linearity error		_	-	±1.5	LSB
G _e	gain error		_	_	1	%
GS _e	small-signal gain error	$\Delta V_i = 16 LSB$	_	_	5	%
CMRR	common-mode rejection ratio		_	60	_	dB
SNRR	supply noise rejection ratio	$f = 100 \text{ Hz};$ $V_{DDN} = 0.1 \times V_{PP}$	_	40	_	dB
t _{ADC}	conversion time		_	_	90	μs
f _{ADC}	sampling/conversion rate		_	_	11.1	kHz

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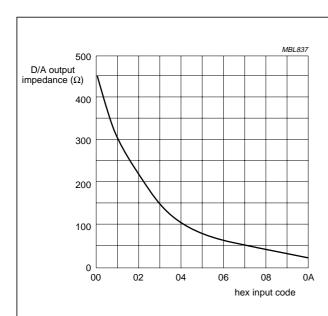


MBL836 160 I_{DD} (μA) -40 °c 120 +27 80 +85 °c 40 3 $V_{DD}(V)$

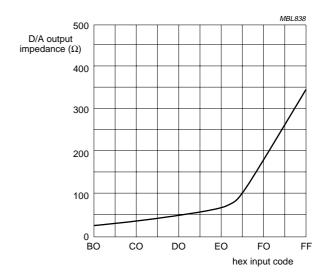
a. Internal oscillator; $T_{amb} = +27^{\circ} C$.

b. External oscillator.

Fig.18 Operating supply current as a function of supply voltage (analog output disabled).



a. Output impedance near negative power rail;



b. Output impedance near positive power rail; T_{amb} = +27 °C.

The x-axis represents the hex input-code equivalent of the output voltage.

 $T_{amb} = +27 \, ^{\circ}C.$

Fig.19 Output impedance of analog output buffer (near power rails).

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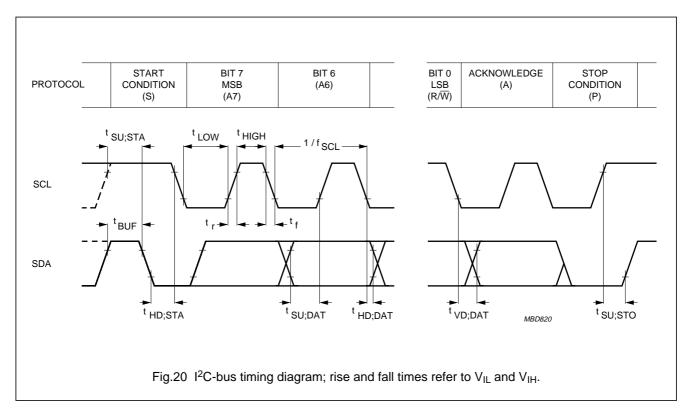
14 AC CHARACTERISTICS

All timing values are valid within the operating supply voltage and ambient temperature range and reference to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD} .

SYMBOL	PARAMETER	MIN.	TYP.	MAX.	UNIT
I ² C-bus timino	g (see Fig.20; note 1)	•	•		
f _{SCL}	SCL clock frequency	_	_	100	kHz
t _{SP}	tolerable spike width on bus	_	_	100	ns
t _{BUF}	bus free time	4.7	_	_	μs
t _{SU;STA}	START condition set-up time	4.7	_	_	μs
t _{HD;STA}	START condition hold time	4.0	_	_	μs
t _{LOW}	SCL LOW time	4.7	_	_	μs
t _{HIGH}	SCL HIGH time	4.0	_	_	μs
t _r	SCL and SDA rise time	_	_	1.0	μs
t _f	SCL and SDA fall time	_	_	0.3	μs
t _{SU;DAT}	data set-up time	250	_	_	ns
t _{HD;DAT}	data hold time	0	_	_	ns
t _{VD;DAT}	SCL LOW-to-data out valid	_	_	3.4	μs
t _{SU;STO}	STOP condition set-up time	4.0	_	_	μs

Note

1. A detailed description of the I²C-bus specification, with applications, is given in brochure "The I²C-bus and how to use it". This brochure may be ordered using the code 9398 393 40011.



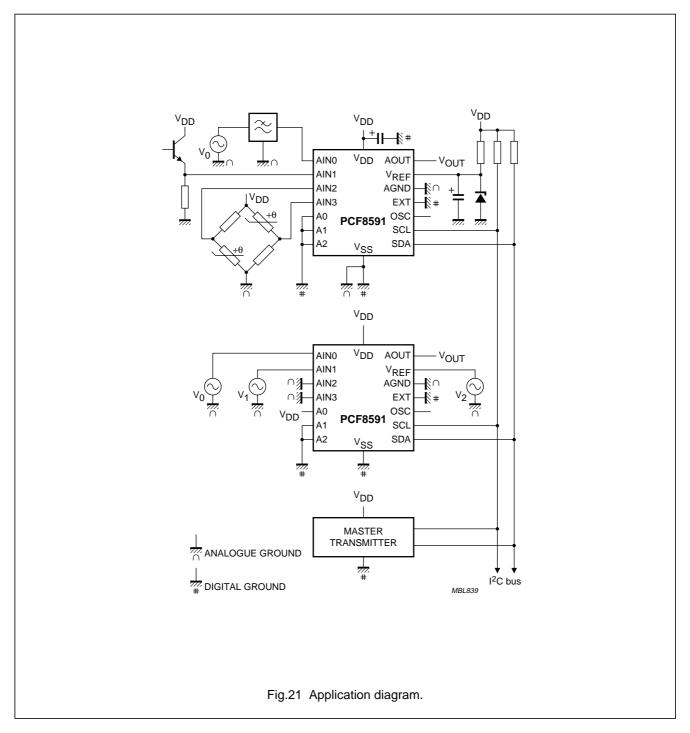
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15 APPLICATION INFORMATION

Inputs must be connected to V_{SS} or V_{DD} when not in use. Analog inputs may also be connected to AGND or V_{REF}.

In order to prevent excessive ground and supply noise and to minimize cross-talk of the digital to analog signal paths the user has to design the printed-circuit board layout very carefully. Supply lines common to a PCF8591 device and noisy digital circuits and ground loops should be avoided. Decoupling capacitors (>10 μ F) are recommended for power supply and reference voltage inputs.



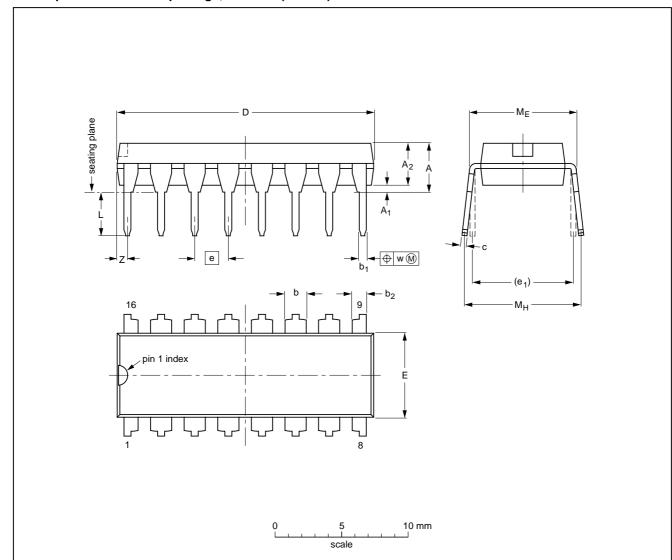
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16 PACKAGE OUTLINES

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

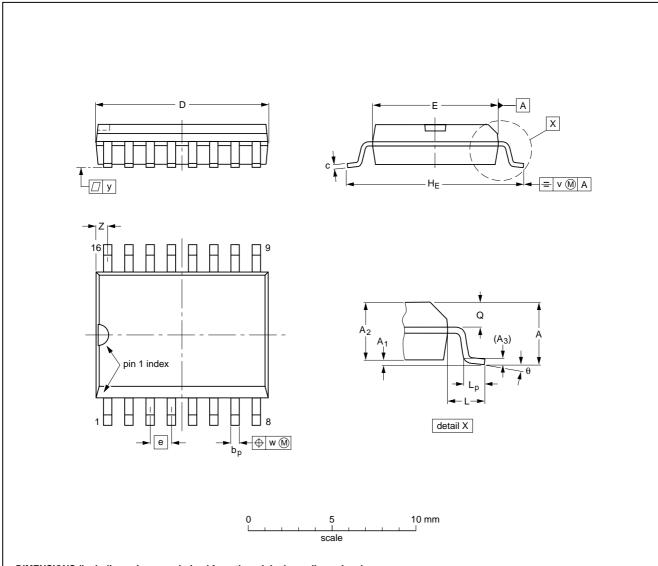
OUTLINE		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT38-4					92-11-17 95-01-14

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SO16: plastic small outline package; 16 leads; body width 7.5 mm

SOT162-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	z ⁽¹⁾	θ
mm	2.65	0.30 0.10	2.45 2.25	0.25	0.49 0.36	0.32 0.23	10.5 10.1	7.6 7.4	1.27	10.65 10.00	1.4	1.1 0.4	1.1 1.0	0.25	0.25	0.1	0.9 0.4	8°
inches	0.10	0.012 0.004	0.096 0.089	0.01	0.019 0.014	0.013 0.009	0.41 0.40	0.30 0.29	0.050	0.419 0.394	0.055	0.043 0.016	0.043 0.039	0.01	0.01	0.004	0.035 0.016	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
SOT162-1	075E03	MS-013			97-05-22 99-12-27

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17 SOLDERING

17.1 Introduction to soldering through-hole mount packages

This text gives a brief insight to wave, dip and manual soldering. A more in-depth account of soldering ICs can be found in our "Data Handbook IC26; Integrated Circuit Packages" (document order number 9398 652 90011).

Wave soldering is the preferred method for mounting of through-hole mount IC packages on a printed-circuit board.

17.2 Soldering by dipping or by solder wave

The maximum permissible temperature of the solder is 260 $^{\circ}$ C; solder at this temperature must not be in contact with the joints for more than 5 seconds.

The total contact time of successive solder waves must not exceed 5 seconds.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified maximum storage temperature ($T_{stg(max)}$). If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

17.3 Manual soldering

Apply the soldering iron (24 V or less) to the lead(s) of the package, either below the seating plane or not more than 2 mm above it. If the temperature of the soldering iron bit is less than 300 °C it may remain in contact for up to 10 seconds. If the bit temperature is between 300 and 400 °C, contact may be up to 5 seconds.

17.4 Suitability of through-hole mount IC packages for dipping and wave soldering methods

PACKAGE	SOLDERING METHOD				
PACKAGE	DIPPING	WAVE			
DBS, DIP, HDIP, SDIP, SIL	suitable	suitable ⁽¹⁾			

Note

1. For SDIP packages, the longitudinal axis must be parallel to the transport direction of the printed-circuit board.

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18 DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
II	Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
III	Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN).

Notes

- 1. Please consult the most recently issued data sheet before initiating or completing a design.
- 2. The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.
- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

19 DEFINITIONS

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

20 DISCLAIMERS

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21 PURCHASE OF PHILIPS I²C COMPONENTS



Purchase of Philips I^2C components conveys a license under the Philips' I^2C patent to use the components in the I^2C system provided the system conforms to the I^2C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.

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Contact information

For additional information please visit http://www.semiconductors.philips.com. Fax: +31 40 27 24825 For sales offices addresses send e-mail to: sales.addresses@www.semiconductors.philips.com.

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Product description

PCF8591; 8-bit A/D and D/A converter





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General description

The PCF8591 is a single-chip, single-supply low power 8-bit CMOS data acquisition device with four analog inputs, one analog output and a serial I^2C -bus interface. Three address pins A0, A1 and A2 are used for programming the hardware address, allowing the use of up to eight devices connected to the I^2C -bus without additional hardware. Address, control and data to and from the device are transferred serially via the two-line bidirectional I^2C -bus.

The functions of the device include analog input multiplexing, on-chip track and hold function, 8-bit analog-to-digital conversion and an 8-bit digital-to-analog conversion. The maximum conversion rate is given by the maximum speed of the I²C-bus.

Features

- Single power supply
- Operating supply voltage 2.5 V to 6 V
- Low standby current
- Serial input/output via I²C-bus
- Address by 3 hardware address pins
- Sampling rate given by I²C-bus speed
- 4 analog inputs programmable as single-ended or differential inputs
- Auto-incremented channel selection
- Analog voltage range from V_{SS} to V_{DD}
- On-chip track and hold circuit
- 8-bit successive approximation A/D conversion
- Multiplying DAC with one analog output.

Applications

- Closed loop control systems
- Low power converter for remote data acquisition
- Battery operated equipment
- Acquisition of analog values in automotive, audio and TV applications.

Application notes

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AN10146_02:I2C 2002-1A Evaluation Board (date 26-Feb-03)

AN10216_1:I2C manual (date 27-Mar-03)

AN96007_1:P83CE258 for High-End RDS/EON Car Radio System CCR520S

V2.5 (date 01-Feb-96)

AN96022_1:High-End RDS/EON Car Radio System CCR520S (V2.6) (date 15-Mar-96)
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Datasheet

<u>Datasheet title</u>	Publication release date	<u>Datasheet status</u>	Page count	File size (kB)	Datasheet
PCF8591; 8-bit A/D and D/A converter	27-Jan-03	Product Specification	28	140	Download

Blockdiagram(s)

■ Block diagram of PCF8591_6

Semiconductors languages

English **x**

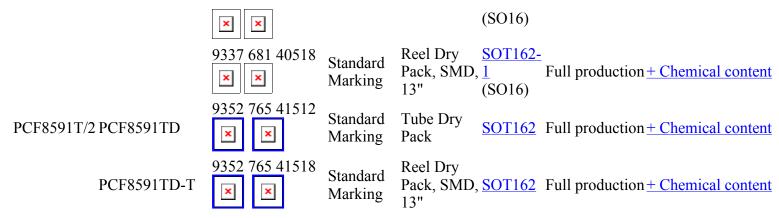
Parametrics

PRODUCTS
PORTAL
PRODUCT
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Type number	Package	Application	FUNCTION	Operating temp. (Cel)	αf	Converter Type	Vdd (max.)	# of Bits	Operating/Supply Voltage (MAX Vcc,Vp,VDD)(V)
PCF8591P		Radio, Audio and CD/DVD Systems	Converters	-40~70	16	Analog-to- Digital	16	8	8
PCF8591T	SOT162- 1 (SO16)	Radio, Audio and CD/DVD Systems	Converters	-40~70	16	Analog-to- Digital	16	8	8
PCF8591T/2	SOT162	Radio, Audio and CD/DVD Systems	Converters	-40~70	16	Analog-to- Digital	16	8	8

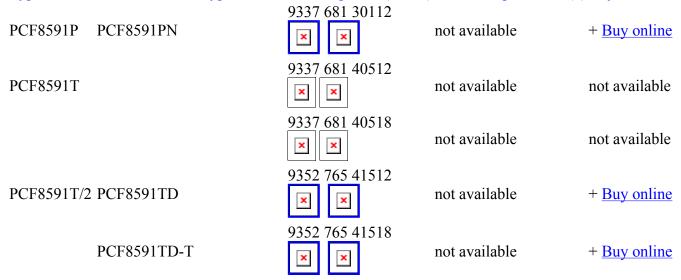
Products and packages

Type number	North American type number	Ordering code (12NC)	Marking	Packing	Package Product status Chemical Content
PCF8591P	PCF8591PN	9337 681 30112	Standard Marking	Bulk Pack	SOT38-4 Full production + Chemical content (DIP16)
PCF8591T		9337 681 40512		Tube Dry Pack	SOT162- Full production + Chemical content 1



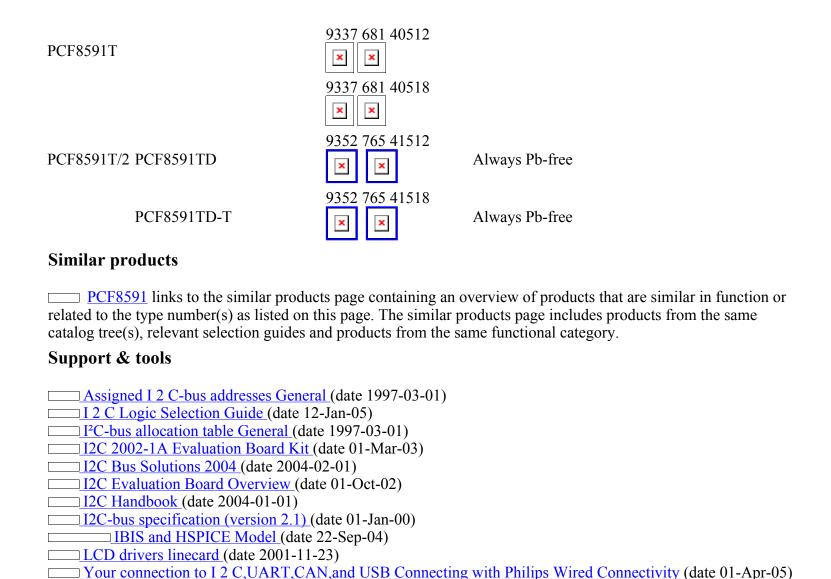
Pricing and availability

Type number North American type number Ordering code (12NC) Indicative price/unit (\$) Buy online



Leadfree status

Type number North American type number Ordering code (12NC) Leadfree conversion date



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